

MAR 21 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 09/884,429 Confirmation No.: 9951
Applicant(s) : David Chazan, et al.
Filing Date : 06/18/2001
TC/A.U. : 1743
Examiner : Brian R. Gordon

Docket No. : 100/09110
Customer No. : 021569
Title : Methods and Devices for Enhancing Bonded Substrate Yields and
Regulating Temperature

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed September 21, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims that begins on page 2 of this paper.

Amendments to the Drawings begin on page 10 of this paper and include an attached replacement sheet(s).

Remarks/Arguments begin on page 11 of this paper.

An **Appendix** including amended drawing figures is attached following page 12 of this paper.